

FS30KM-03

HIGH-SPEED SWITCHING USE

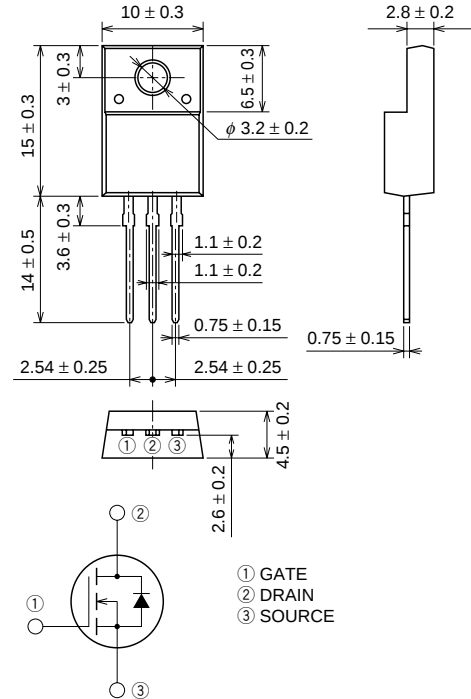
FS30KM-03



- 10V DRIVE
- V_{DS} 30V
- $r_{DS(ON)}(MAX)$ $46m\Omega$
- I_D 30A
- Integrated Fast Recovery Diode (TYP.) 45ns
- V_{iso} 2000V

OUTLINE DRAWING

Dimensions in mm



APPLICATION

Motor control, Lamp control, Solenoid control
DC-DC converter, etc.

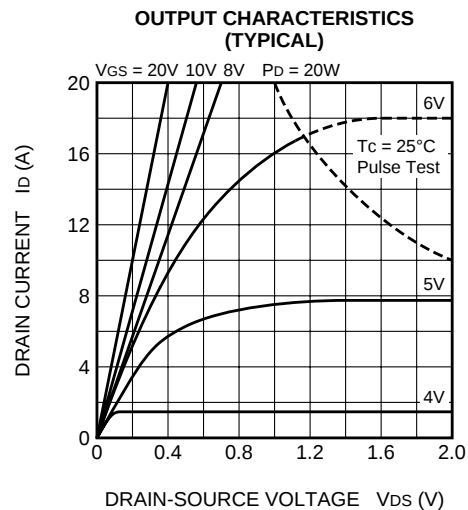
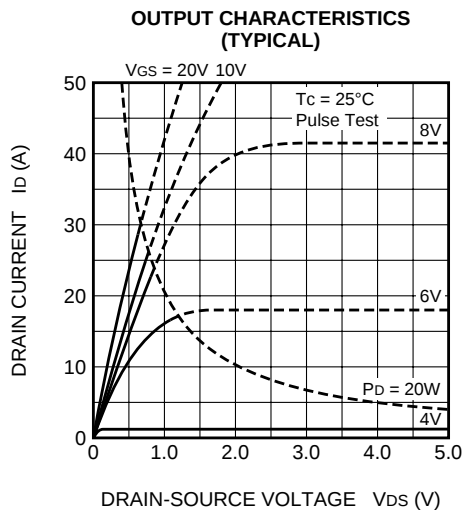
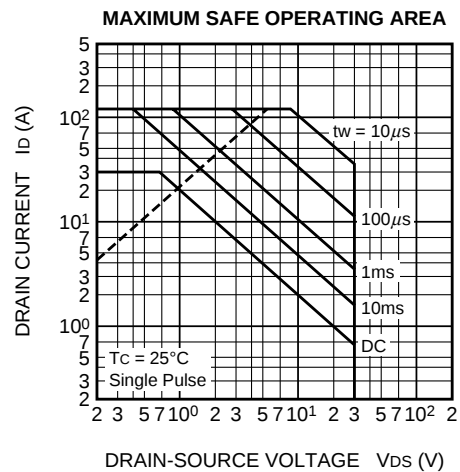
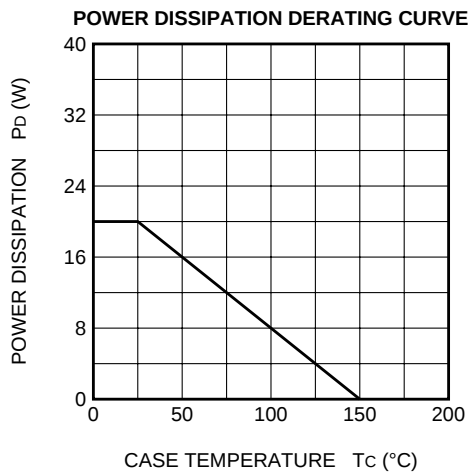
MAXIMUM RATINGS (Tc = 25°C)

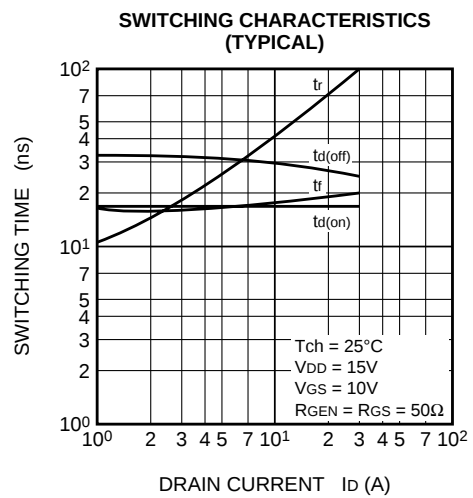
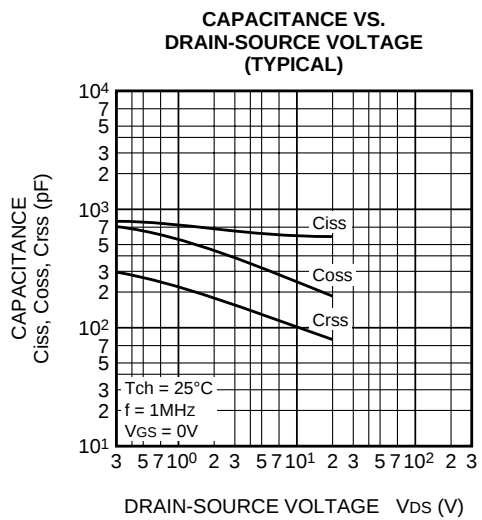
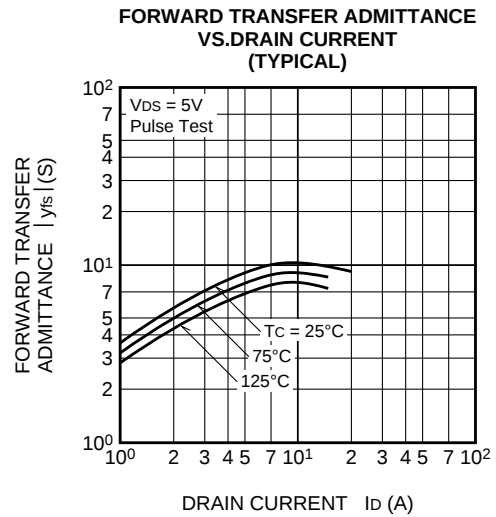
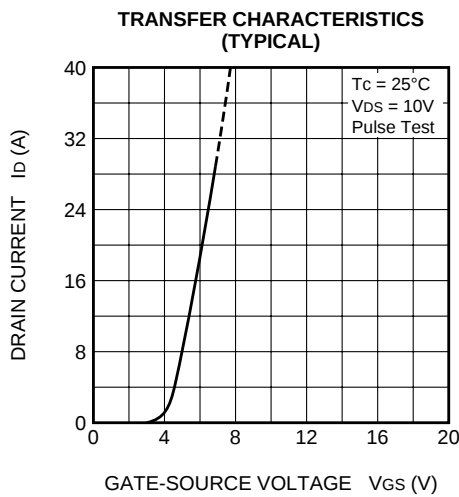
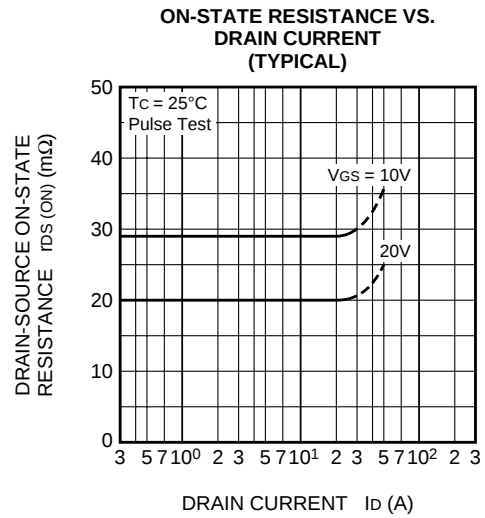
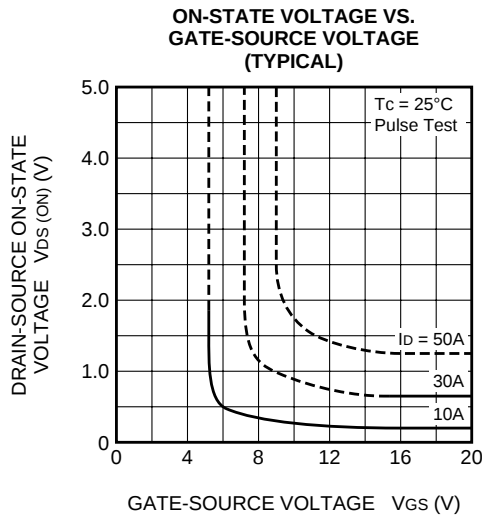
Symbol	Parameter	Conditions	Ratings	Unit
V_{DS}	Drain-source voltage	$V_{GS} = 0V$	30	V
V_{GS}	Gate-source voltage	$V_{DS} = 0V$	± 20	V
I_D	Drain current		30	A
I_{DM}	Drain current (Pulsed)		120	A
I_{DA}	Avalanche drain current (Pulsed)	$L = 30\mu H$	30	A
I_S	Source current		30	A
I_{SM}	Source current (Pulsed)		120	A
P_D	Maximum power dissipation		20	W
T_{ch}	Channel temperature		$-55 \sim +150$	°C
T_{stg}	Storage temperature		$-55 \sim +150$	°C
V_{iso}	Isolation voltage	AC for 1minute, Terminal to case	2000	V
—	Weight	Typical value	2.0	g

ELECTRICAL CHARACTERISTICS (Tch = 25°C)

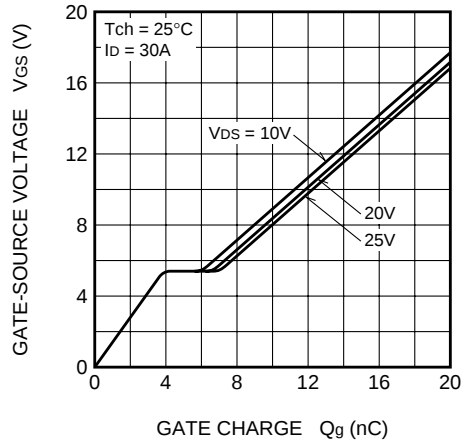
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	Id = 1mA, VGS = 0V	30	—	—	V
IGSS	Gate-source leakage current	VGS = ±20V, VDS = 0V	—	—	±0.1	μA
IDSS	Drain-source leakage current	VDS = 30V, VGS = 0V	—	—	0.1	mA
VGS(th)	Gate-source threshold voltage	Id = 1mA, VDS = 10V	2.0	3.0	4.0	V
rDS(on)	Drain-source on-state resistance	Id = 15A, VGS = 10V	—	36	46	mΩ
VDS(on)	Drain-source on-state voltage	Id = 15A, VGS = 10V	—	0.54	0.69	V
yfs	Forward transfer admittance	Id = 15A, VDS = 5V	—	11	—	S
Ciss	Input capacitance	VDS = 10V, VGS = 0V, f = 1MHz	—	600	—	pF
Coss	Output capacitance		—	250	—	pF
Crss	Reverse transfer capacitance		—	110	—	pF
td(on)	Turn-on delay time	VDD = 15V, Id = 15A, VGS = 10V, RGEN = RGS = 50Ω	—	18	—	ns
tr	Rise time		—	65	—	ns
td(off)	Turn-off delay time		—	30	—	ns
tf	Fall time		—	25	—	ns
VSD	Source-drain voltage	Is = 15A, VGS = 0V	—	1.0	1.5	V
Rth(ch-c)	Thermal resistance	Channel to case	—	—	6.25	°C/W
trr	Reverse recovery time	Is = 15A, dis/dt = -50A/μs	—	45	—	ns

PERFORMANCE CURVES

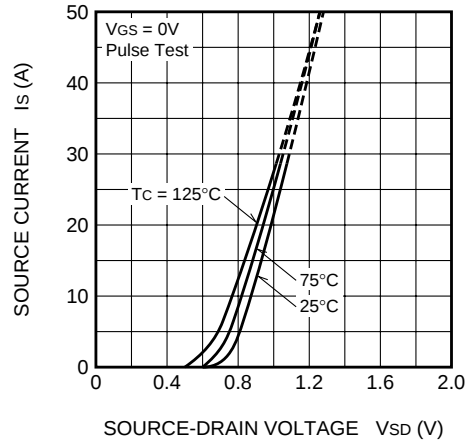




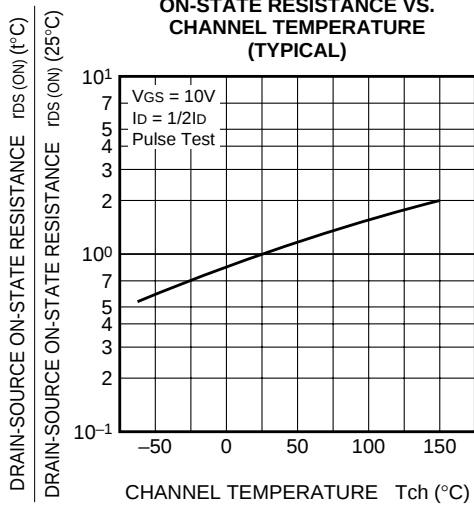
GATE-SOURCE VOLTAGE
VS. GATE CHARGE
(TYPICAL)



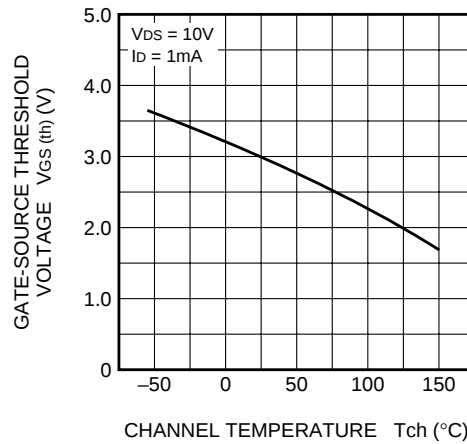
SOURCE-DRAIN DIODE
FORWARD CHARACTERISTICS
(TYPICAL)



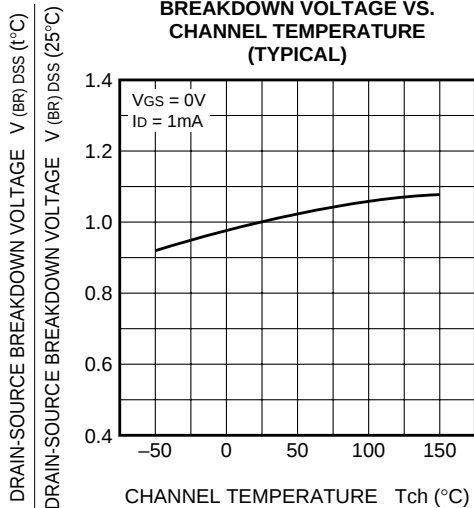
ON-STATE RESISTANCE VS.
CHANNEL TEMPERATURE
(TYPICAL)



THRESHOLD VOLTAGE VS.
CHANNEL TEMPERATURE
(TYPICAL)



BREAKDOWN VOLTAGE VS.
CHANNEL TEMPERATURE
(TYPICAL)



TRANSIENT THERMAL IMPEDANCE
CHARACTERISTICS

